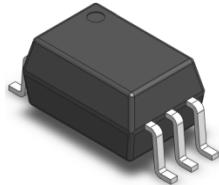
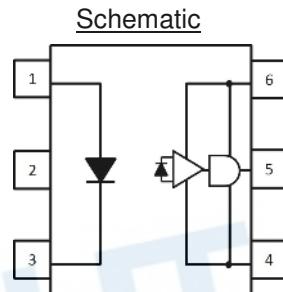


6 PIN SDIP INTELLIGENT POWER and GATE DRIVE INTERFACE PHOTOCOUPLER ELS680-G series

Preliminary

Features

- Compliance Halogens Free
(Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- Pb free and RoHS compliant
- Compliance with EU REACH.
- High isolation voltage between input and output (Viso=5000 Vrms)
- UL and cUL pending
- VDE pending
- NEMKO pending
- FIMKO pending
- SEMKO pending
- DEMKO pending
- CQC pending



A 0.1 μ F bypass capacitor must be connected between pins 6 and 4³

Pin Configuration

- 1: Anode
- 2: No Connection
- 3: Cathode
- 4: V_{EE}
- 5: V_{out}
- 6: V_{CC}

This is a preliminary specification intended for design purposes and subject to change without prior notice.

Description

The ELS680-G series devices each consists of an infrared emitting diode, optically coupled to a high speed integrated photo detector logic gate with a totem output. The totem pole output eliminates the need for a pull-up resistor and allows for a direct-drive Intelligent Power Module or gate drive. The devices are packaged in a 6-pin small DIP package.

Applications

- IPM Interface Isolation
- Isolated IGBT/MOSFET Gate Drive
- AC and Brushless DC Motor Drives
- Industrial Inverters

Truth Table

Input	Output
H	H
L	L

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I _F	25	mA
	Reverse voltage	V _R	5	V
	Power dissipation	P _{IN}	75	mW
Output	Average Output current	I _{O(AVG)}	60	mA
	Supply voltage	V _{CC}	30	V
	Power dissipation	P _O	270	mW
Total Power Dissipation		P _{TOT}	350	mW
Isolation voltage ^{*1}		V _{ISO}	5000	Vrms
Operating temperature		T _{OPR}	-40 ~ +100	°C
Storage temperature		T _{STG}	-55 ~ +125	°C
Soldering temperature ^{*2}		T _{SOL}	260	°C

Notes:

^{*1} AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2, 3 are shorted together, and pins 4, 5, 6, are shorted together.

^{*2} For 10 seconds.

Electrical Characteristics (Ta=-40 to 100 °C unless specified otherwise)**Input**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Voltage	V_F	-	1.5	1.8	V	$I_F=10\text{mA}$
Reverse Voltage	I_R	-	-	10	μA	$V_R=5\text{V}$
Input Capacitance	C_{IN}	-	60	-	pF	$V_F=0\text{V}$, $f=1\text{MHz}$

Output

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
High Level Supply Current	I_{CCH}	-	-	3.2	mA	$V_{CC}=5.5\text{V}$, $I_F=10\text{mA}$
Low Level Supply Current	I_{CCL}	-	-	3.2	mA	$V_{CC}=5.5\text{V}$, $I_F=0\text{mA}$
Logic High Short Circuit Output Current,	I_{OSH}	-	-	-60	mA	$V_{CC}=5.5\text{V}$, $I_F=10\text{mA}$, $I_O=\text{Open}$
Logic Low Short Circuit Output Current,	I_{OSL}	60	-		mA	$V_{CC}=V_O=5.5\text{V}$, $V_F=0\text{V}$

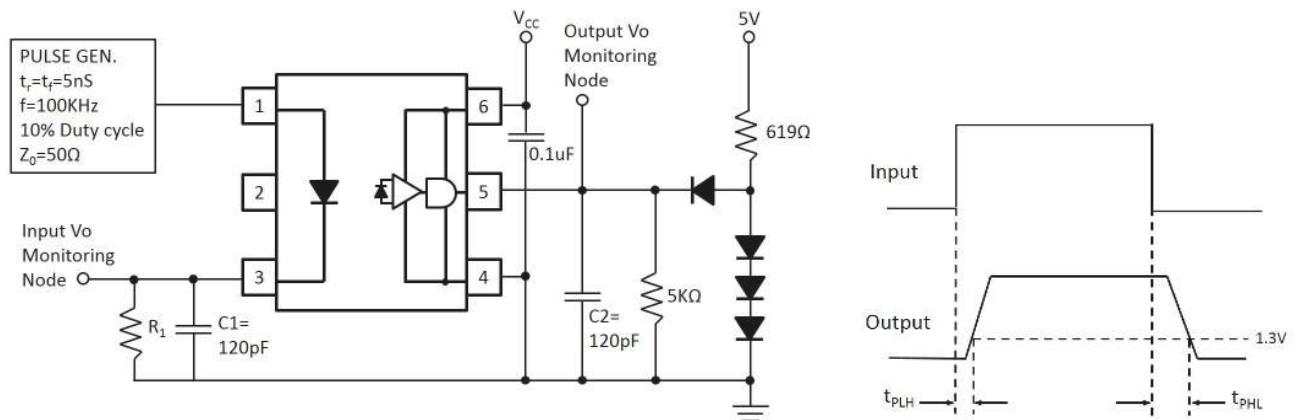
Transfer Characteristics (Ta=-40 to 100 °C unless specified otherwise)

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
High Level Output Voltage	V_{OH}	$V_{CC}-0.5$	-	-	V	$V_{CC}=4.5\text{V}$, $I_F=10\text{mA}$, $I_O=-0.4\text{mA}$
Low Level Output Voltage	V_{OL}	-	-	$V_{EE}+0.5$	V	$V_{CC}=4.5\text{V}$, $I_F=0\text{mA}$, $I_O=6.4\text{mA}$
Input Threshold Current	I_{IT}	-	2.5	5	mA	$V_{CC}=4.5\text{V}$
Input-Output Resistance	R_{I-O}	-	10^{12}	-	Ω	$V_{I-O}=500\text{V DC}$
Input-Output Capacitance	C_{I-O}	-	0.6	-	pF	$V_{I-O}=0\text{V DC}$, $f=1\text{MHz}$

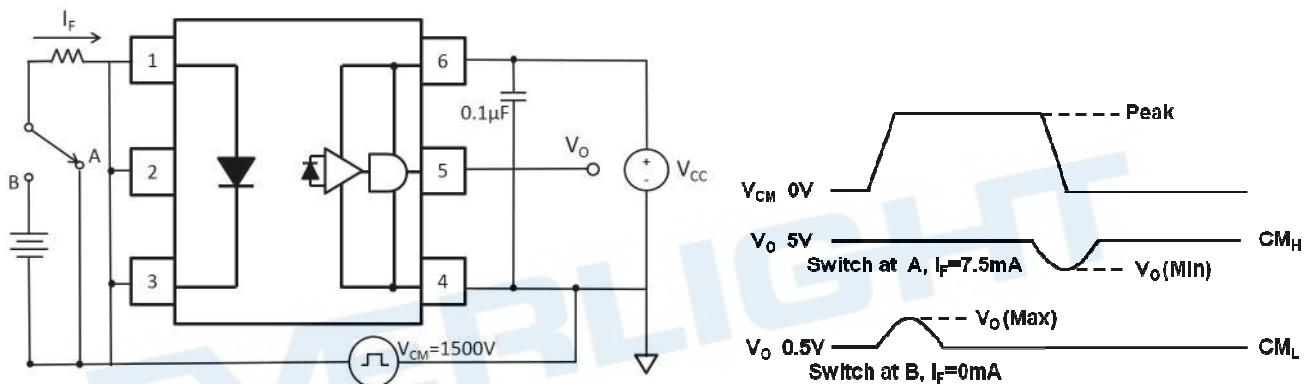
Switching Characteristics (T_a=-40 to 100°C, V_{CC}=4.5V, I_F=10mA unless specified otherwise)

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Propagation Delay Time to Output High Level ^{*5}	t _{PHL}	-	130	350	ns	V _{CC} =4.5V, I _F =10mA T _A =25°C
Propagation Delay Time to Output Low Level ^{*6}	t _{PLH}	-	140	350	ns	V _{CC} =4.5V, I _F =10mA T _A =25°C
Pulse Width Distortion	t _{PHL} - t _{PLH}	-	-	250	ns	V _{CC} =4.5V, I _F =10mA T _A =25°C
Output Rise Time ^{*7}	tr	-	9	-	ns	V _{CC} =4.5V, I _F =10mA T _A =25°C
Output fall time ^{*8}	tf	-	6	-	ns	V _{CC} =4.5V, I _F =10mA T _A =25°C
Common Mode Transient Immunity at Logic High ^{*3}	CM _H	10	-	-	KV/μs	V _{CM} =1500Vp-p, I _F =7.5mA, V _{CC} =5V, T _A =25°C
Common Mode Transient Immunity at Logic Low ^{*3}	CM _L	10	-	-	KV/μs	V _{CM} =1500Vp-p, I _F =0mA, V _{CC} =5V, T _A =25°C

Switching Time Test Circuit & Waveform



Transient Immunity Test Circuit & Waveform



Note:

- *3 The V_{CC} supply must be bypassed by a $0.1\mu\text{F}$ capacitor or larger. This can be either a ceramic or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible to the package V_{CC} and V_{EE} pins
- *4 Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{CM}/dt on the leading edge of the common mode pulse signal V_{CM} , to assure that the output will remain in a logic high state (i.e., $V_o > 2.0\text{V}$). Common mode transient immunity in logic low level is the maximum tolerable (negative) dV_{CM}/dt on the trailing edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a logic low state (i.e., $V_o < 0.8\text{V}$)

Order Information

Part Number

ELS680X(Y) -VG

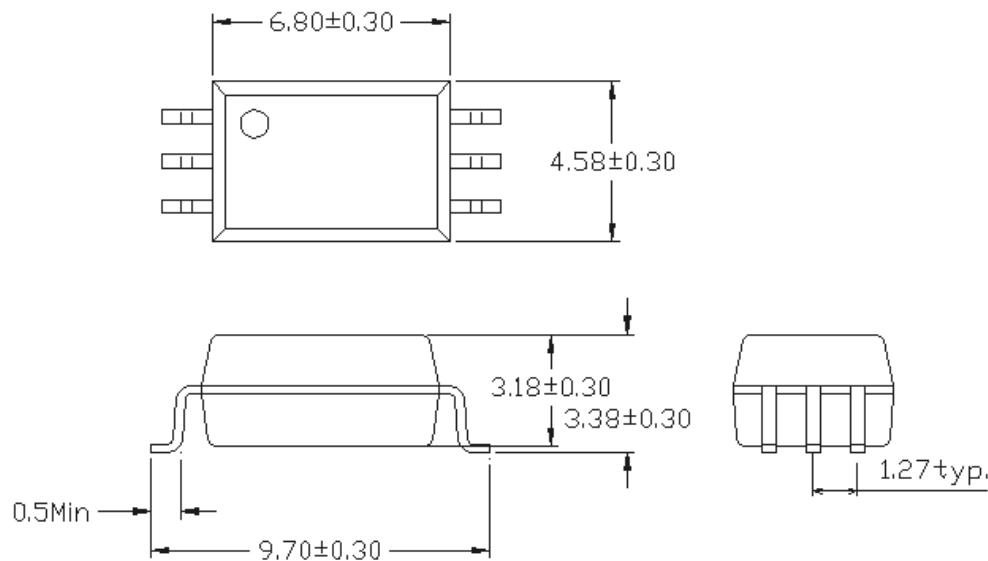
Note

EL = denotes EVERLIGHT
S680 = part no.
X = lead type(P)
Y = Tape and reel option (TA, TB)
V = VDE (optional)
G = Halogens free

Option	Description	Packing quantity
P(TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
P(TB)	Surface mount lead form + TB tape & reel option	1000 units per reel

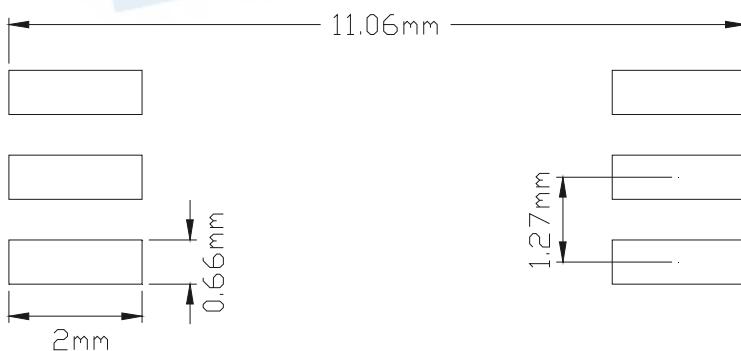
Package Dimension (Dimensions in mm)

P Type

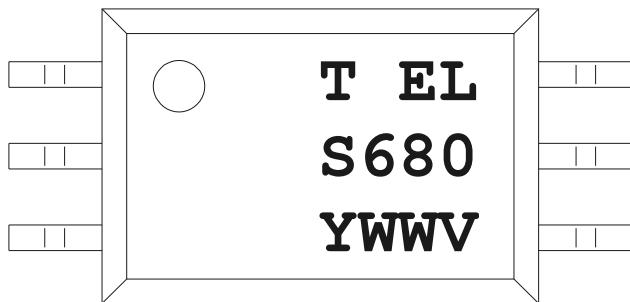


Recommended pad layout for surface mount leadform

For P Type:



Device Marking

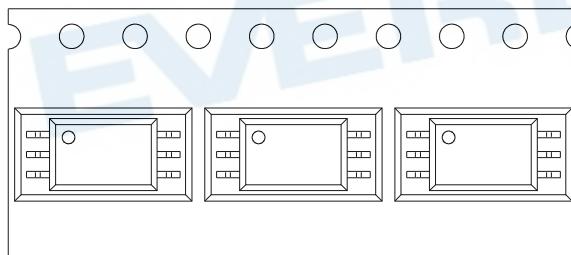


Notes

T	denotes Factory T : made in Taiwan
EL	denotes EVERLIGHT
S680	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

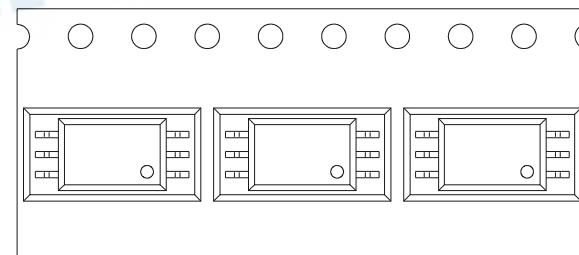
Tape & Reel Packing Specifications

Option TA

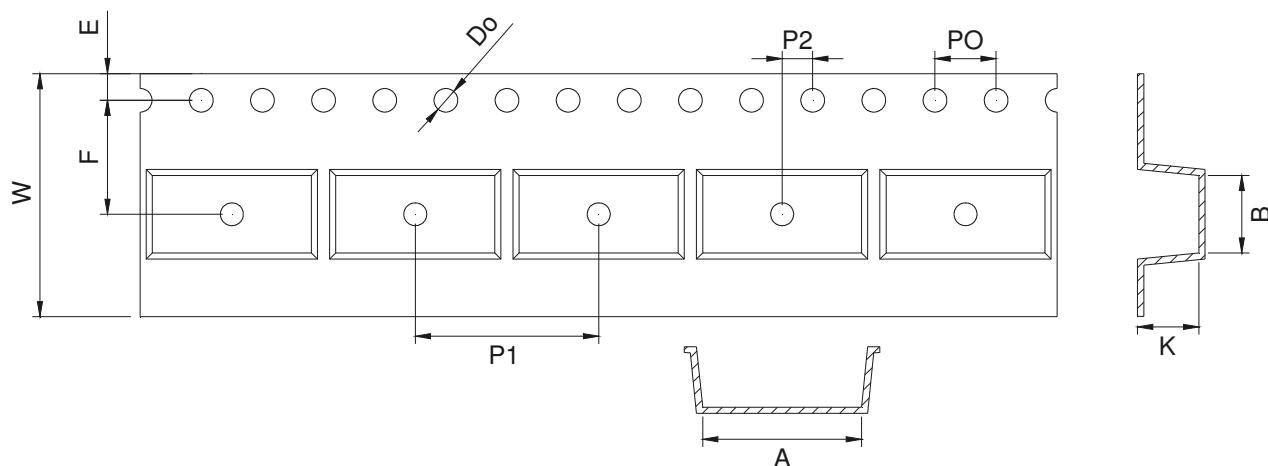


Direction of feed from reel

Option TB



Direction of feed from reel

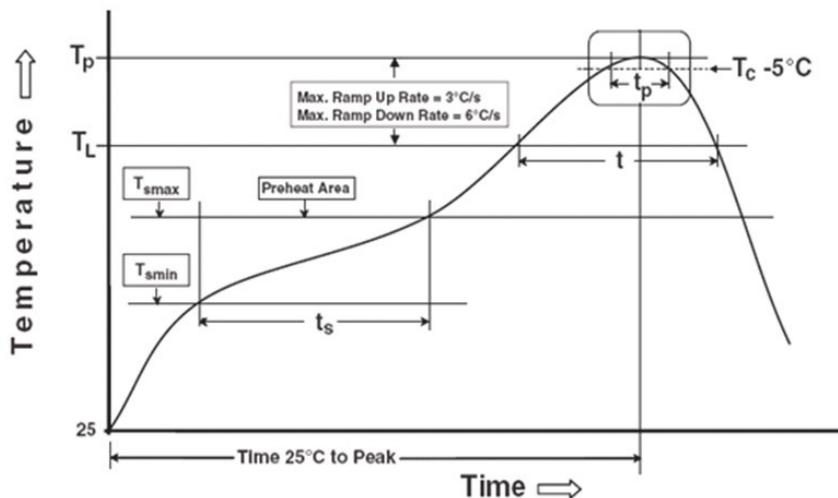
Tape dimension

Dimension No.	A	B	Do	E	F	t
Dimension(mm) P	10.4 ± 0.1	5.1 ± 0.1	1.55 ± 0.1	1.75 ± 0.1	7.5 ± 0.1	0.4 ± 0.1
Dimension No.	P	P1	P2	W	K	
Dimension(mm) P	4.0 ± 0.1	12.0 ± 0.1	2.0 ± 0.1	16.0 ± 0.3	4.0 ± 0.1	

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_p)	260°C
Time within 5 °C of Actual Peak Temperature: $T_p - 5°C$	30 s
Ramp- Down Rate from Peak Temperature	6 °C /second max.
Time 25 °C to peak temperature	8 minutes max.
Reflow times	3 times

DISCLAIMER

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2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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